# **BGU7031**

# 1 GHz wideband low-noise amplifier Rev. 2 — 7 September 2010

**Product data sheet** 

#### **Product profile** 1.

#### 1.1 General description

The BGU7031 MMIC is a wideband amplifier with internal biasing. It is designed specifically for high linearity, low-noise applications over a frequency range of 40 MHz to 1 GHz. It is especially suited to Set-Top Box applications.

The LNA is housed in a 6-pin SOT363 plastic SMD package.

#### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

### 1.2 Features and benefits

- Internally biased
- Flat gain between 40 MHz and 1 GHz
- Noise figure of 4.5 dB
- High linearity with an IP3<sub>O</sub> of 29 dBm
- 75 Ω input and output impedance
- ESD protection > 2 kV Human Body Model (HBM) on all pins

#### 1.3 Applications

- Terrestrial and cable Set-Top Boxes (STB)
- Silicon and "Can" tuners
- Personal and Digital Video Recorders (PVR and DVR)
- Home networking and in-house signal distribution



#### 1 GHz wideband low-noise amplifier

#### 1.4 Quick reference data

Table 1. Quick reference data

 $T_{amb}$  = 25 °C; typical values at  $V_{CC}$  = 5 V;  $Z_S$  =  $Z_L$  = 75  $\Omega$ ;  $R_{bias}$  = 43  $\Omega$ ; 40 MHz  $\leq$   $f_1 \leq$  1000 MHz.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{CC}$	supply voltage	RF input AC coupled		4.75	5.0	5.25	V
I <sub>CC(tot)</sub>	total supply current		<u>[1]</u>	-	43	-	mA
T <sub>amb</sub>	ambient temperature			-10	+25	+70	°C
NF	noise figure			-	4.5	-	dB
$P_{L(1dB)}$	output power at 1 dB gain compression	1 GHz		-	13	-	dBm
IP3 <sub>O</sub>	output third-order intercept point		[2]	-	29	-	dBm

 $<sup>\</sup>label{eq:cctot} [1] \quad I_{CC(tot)} \mbox{ is configurable with external resistor.}$ 

# 2. Pinning information

Table 2. Pinning

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Pin	Description	Simplified outline	Graphic symbol
1	RF_OUT		
2	V <sub>CC</sub>	6   5   4	$\begin{pmatrix} 3 & 2 \\ 1 & 1 \end{pmatrix}$
3	n.c.		6 — 1
4	n.c.	0	
5	GND	□1 □2 □3	5 4 sym141
6	RF_IN		,

# 3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BGU7031	-	plastic surface-mounted package; 6 leads	SOT363		

# 4. Marking

Table 4. Marking codes

Type number	Marking code
BGU7031	SC%

Note: % character indicates the location of production.

<sup>[2]</sup> The fundamental frequency ( $f_1$ ) lies between 40 MHz and 1000 MHz. The intermodulation product (IM3) is  $2 \times f_2 - f_1$ , where  $f_2 = f_1 \pm 1$  MHz. Input power  $P_i = -10$  dBm.

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# 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{CC}$	supply voltage	RF input AC coupled		-0.6	5.25	V
I <sub>CC(tot)</sub>	total supply current	configurable with external resistor		-	60	mA
P <sub>tot</sub>	total power dissipation	T <sub>sp</sub> ≤ 100 °C	[1]	-	250	mW
Pi	input power	single tone		-	10	dBm
T <sub>stg</sub>	storage temperature			-65	+150	°C
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-10	+70	°C
V <sub>ESD</sub>	electrostatic discharge voltage	Human Body Model (HBM); according to JEDEC standard 22-A114E		2	-	kV

<sup>[1]</sup>  $T_{sp}$  is the temperature at the solder point of the ground lead.

## 6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point		240	K/W

# 7. Characteristics

Table 7. Characteristics

 $T_{amb}$  = 25 °C; typical values at  $V_{CC}$  = 5 V;  $Z_S$  =  $Z_L$  = 75  $\Omega$ ;  $R_{bias}$  = 43  $\Omega$ ; 40 MHz  $\leq$   $f_1 \leq$  1000 MHz.

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage	RF input AC coupled	4.75	5.0	5.25	V
$I_{CC(tot)}$	total supply current		-	43	-	mA
$ s_{21} ^2$	insertion power gain		-	10		dB
SL <sub>sl</sub>	slope straight line		-	-1	-	dB
FL	flatness of frequency response		-	-0.2	-	dB
NF	noise figure		-	4.5	-	dB
$RL_{in}$	input return loss		-	18	-	dB
$RL_{out}$	output return loss		-	12	-	dB
P <sub>L(1dB)</sub>	output power at 1 dB gain compression	1 GHz	-	14	-	dBm
IP3 <sub>O</sub>	output third-order intercept point	<u>[</u>	<u>1]</u> _	29	-	dBm

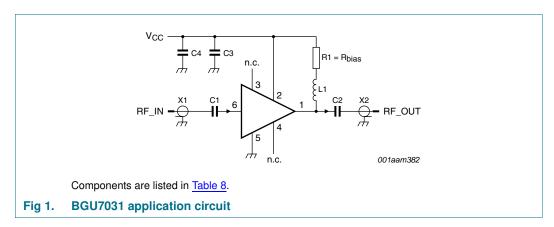
<sup>[1]</sup> The fundamental frequency ( $f_1$ ) lies between 40 MHz and 1000 MHz. The intermodulation product (IM3) is  $2 \times f_2 - f_1$ , where  $f_2 = f_1 \pm 1$  MHz. Input power  $P_i = -10$  dBm.

### 1 GHz wideband low-noise amplifier

# 8. Application information

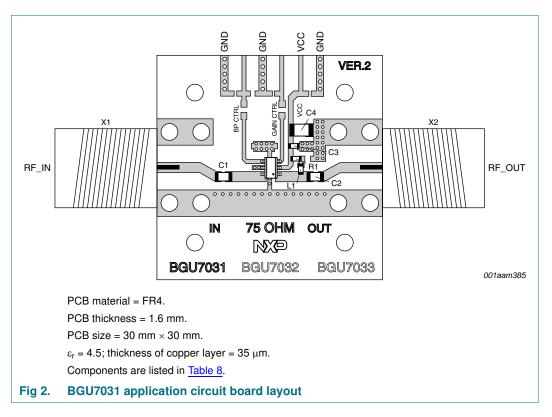
Other applications are possible. Please contact your local sales representative for more information. Application notes are available on the NXP website.

# 8.1 Application circuit



All control and supply lines must be decoupled properly. The decoupling capacitors must be placed as close to the device as possible.

# 8.2 Application circuit board layout



**BGU7031 NXP Semiconductors** 

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Table 8. List of components See Figure 1 and Figure 2.

Component	Description	Value	Remarks	Function
C1, C2	capacitor	10 nF		DC blocking
C3	capacitor	10 nF		decoupling
C4	capacitor	10 μF		decoupling
L1	chip ferrite bead	$1.5~\mathrm{k}\Omega$	Murata BLM18HE152SN1DF	RF choke
R1	resistor	43 Ω	[1] R <sub>bias</sub>	bias setting
X1, X2	connector	75 Ω	F-connector, edge mount PCB reflow type, Bomar 861V509ERG	input/output

<sup>[1]</sup> L1 and R1 must have a power rating of 0.1 W or higher.

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# 9. Package outline

# Plastic surface-mounted package; 6 leads

**SOT363** 

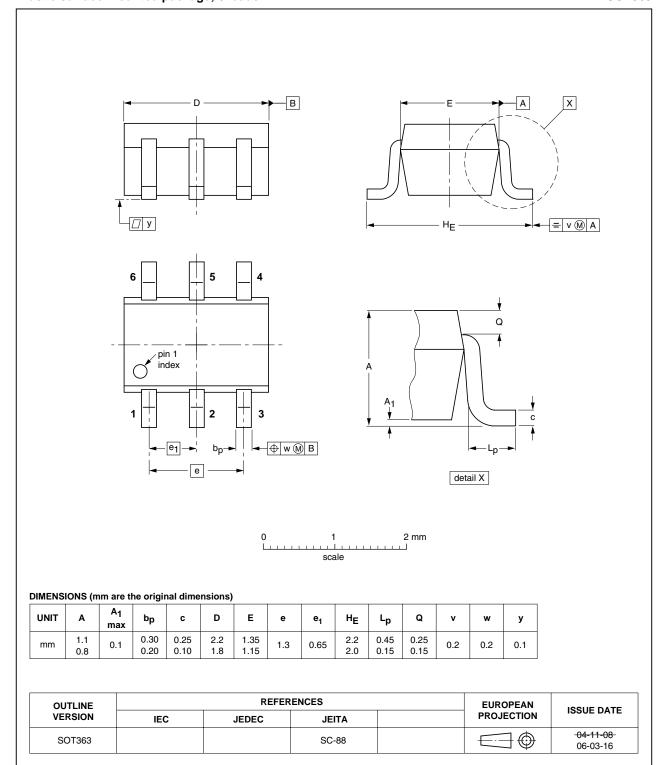


Fig 3. Package outline SOT363

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# 1 GHz wideband low-noise amplifier

# 10. Abbreviations

Table 9. Abbreviations

Acronym	Description
AC	Alternating Current
DC	Direct Current
LNA	Low-Noise Amplifier
MMIC	Monolithic Microwave Integrated Circuit
PCB	Printed-Circuit Board
RF	Radio Frequency
SMD	Surface-Mounted Device

# 11. Revision history

### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGU7031 v.2	20100907	Product data sheet	-	BGU7031 v.1
Modifications:	<ul> <li>The status of this data sheet has been changed to Product data sheet.</li> <li>Table 5 on page 3: The minimum value for V<sub>CC</sub> has been added.</li> </ul>			
BGU7031 v.1	20100812	Preliminary data sheet	-	- -

#### 1 GHz wideband low-noise amplifier

# 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
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